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Date: January 28, 2003

By: Markus NOLFF

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor	:	Harry Hedler et al.
Applic. No.	:	10/056,356
Filed	:	January 24, 2002
Title	:	Electronic Component with a Semiconductor Chip and Method of Producing the Electronic Component
Examiner	:	Hung V. Ngo - Art Unit: 2831

RESPONSE

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

Sir:

Responsive to the Office Action dated January 14, 2003, the following remarks are made:

In deference to the restriction requirement on pages 2 and 3 of the above-identified Office Action, applicants elect group I, claims 1-12, for prosecution at this time.

Applicants request a rejoinder under MPEP §821.04.

In view of the foregoing, the early issuance of an Action on the merits of claims 1-12 is solicited.

Respectfully submitted,

Markus NOLFF
For Applicants

MARKUS NOLFF
REG. NO. 37,006

Date: January 28, 2003

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